

Advance Technical Information

Polar[™] Power MOSFET HiPerFET[™]

IXFL32N120P

N-Channel Enhancement Mode

Avalanche Rated Fast Intrinsic Diode

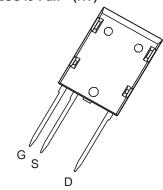


| Symbol | Test Conditions | Maximum Ratings | | |
|------------------------------|---|-----------------|-------|--|
| V _{DSS} | $T_{_{\rm J}} = 25^{\circ}\text{C to } 150^{\circ}\text{C}$ | 1200 | V | |
| V_{DGR} | $T_{_{ m J}}$ = 25°C to 150°C, $R_{_{ m GS}}$ = 1M Ω | 1200 | V | |
| V _{GSS} | Continuous | ± 30 | V | |
| V _{GSM} | Transient | $\pm~40$ | V | |
| I _{D25} | T _c = 25°C | 24 | А | |
| I _{DM} | $T_{\rm C} = 25^{\circ}$ C, pulse width limited by $T_{\rm JM}$ | 100 | Α | |
| I _A | $T_{c} = 25^{\circ}C$ | 16 | Α | |
| E _{AS} | $T_{c} = 25^{\circ}C$ | 2 | J | |
| dV/dt | $I_{_{S}} \le I_{_{DM}}, \ V_{_{DD}} \le V_{_{DSS}}, T_{_{J}} \le 150^{\circ}C$ | 20 | V/ns | |
| $\overline{P_{D}}$ | T _C = 25°C | 520 | W | |
| T | | -55 +150 | °C | |
| \mathbf{T}_{JM} | | 150 | °C | |
| T_{stg} | | -55 +150 | °C | |
| T _L | Maximum lead temperature for soldering | 300 | °C | |
| $\mathbf{T}_{\mathtt{SOLD}}$ | Plastic body for 10s | 260 | °C | |
| V _{ISOL} | 50/60 Hz, RMS, 1 minute | 2500 | V~ | |
| | $I_{ISOL} \le 1 \text{mA}$ $t = 1 \text{s}$ | 3000 | V~ | |
| F _c | Mounting force | 40120/4.527 | N/lb. | |
| Weight | | 8 | g | |

| SymbolTest ConditionsCharacteristics $(T_J = 25^{\circ}C, unless otherwise specified)$ Min. | | racteristic Values Typ. Max. | | | |
|---|--|-----------------------------------|--|-------|----|
| BV _{DSS} | $V_{GS} = 0V, I_{D} = 3mA$ | 1200 | | | V |
| V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = 1 \text{mA}$ | 3.5 | | 6.5 | V |
| I _{GSS} | $V_{GS} = \pm 30V, V_{DS} = 0V$ | | | ± 300 | nA |
| I _{DSS} | $V_{DS} = V_{DSS}$ | | | 50 | μА |
| | $V_{GS} = 0V$ $T_J = 125^{\circ}C$ | | | 5 | mA |
| R _{DS(on)} | $V_{GS} = 10V, I_{D} = 16A, \text{ Note } 1$ | | | 340 | mΩ |

 $V_{DSS} = 1200V$ $I_{D25} = 24A$ $R_{DS(on)} \le 340m\Omega$ $t_{rr} \le 300ns$

ISOPLUS i5-Pak™ (HV)



G = GateS = Source D = Drain

Features

- UL recognized package
- Silicon chip on Direct-Copper-Bond substrate
- High power dissipation
- Isolated mounting surface
- 2500V electrical isolation
- Unclamped Inductive Switching (UIS) rated
- Low package inductance
- easy to drive and to protect
- Fast intrinsic diode

Advantages

- Easy to mount
- Space savings
- High power density

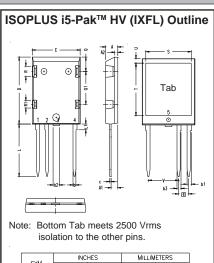
Applications:

- High Voltage Switched-mode and resonant-mode power supplies
- High Voltage Pulse Power Applications
- High Voltage Discharge circuits in Lasers Pulsers, Spark Igniters, RF Generators
- High Voltage DC-DC converters
- High Voltage DC-AC inverters



| Symbol | Test Conditions | | Characteristic Values | | |
|-------------------------|---|------|-----------------------|-----------|--|
| $(T_J = 25^{\circ}C u)$ | nless otherwise specified) | Min. | Тур. | Max. | |
| g _{fs} | $V_{DS} = 20V, I_{D} = 16A, Note 1$ | 17 | 28 | S | |
| C _{iss} | | | 21 | nF | |
| C _{oss} | $V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$ | | 1100 | pF | |
| C _{rss} | | | 77 | pF | |
| R_{Gi} | Gate input resistance | | 0.84 | Ω | |
| t _{d(on)} | Resistive Switching Times | | 70 | ns | |
| t, | • | | 62 | ns | |
| t _{d(off)} | $V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 16A$ | | 88 | ns | |
| t, | $R_{_{\rm G}} = 1\Omega$ (External) | | 58 | ns | |
| Q _{g(on)} | | | 360 | nC | |
| Q _{gs} | $V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 16A$ | | 130 | nC | |
| Q_{gd} | | | 160 | nC | |
| R _{thJC} | | | | 0.24 °C/W | |
| \mathbf{R}_{thCS} | | | 0.15 | °C/W | |

| Source-Drain Diode T ₁ = 25°C unless otherwise specified) | Characteristic Values Min. Typ. Max. |
|--|---|
| I_s $V_{GS} = 0V$ | 32 A |
| I _{sm} Repetitive, pulse width limited | by T _{JM} 128 A |
| V_{SD} $I_F = I_S$, $V_{GS} = 0V$, Note 1 | 1.5 V |
| t_{rr} $I_{E} = 20A, -di/dt = 100A/\mu s$ | 300 ns |
| Q_{RM} $V_{R} = 100V, V_{GS} = 0V$ | 1.9 μC |
| L H GS | 15 A |



| 0.44 | INCHES | | MILLIMETERS | | |
|------|----------|-------|-------------|-------|--|
| SYM | MIN | MAX | MIN | MAX | |
| Α | .190 | .205 | 4.83 | 5.21 | |
| A1 | .102 | .118 | 2.59 | 3.00 | |
| A2 | .046 | .055 | 1.17 | 1.40 | |
| b | .045 | .055 | 1.14 | 1.40 | |
| ь1 | .063 | .072 | 1.60 | 1.83 | |
| b2 | .100 | .110 | 2.54 | 2.79 | |
| b3 | .058 | .068 | 1.47 | 1.73 | |
| С | .020 | .029 | 0.51 | 0.74 | |
| D | 1.020 | 1.040 | 25.91 | 26.42 | |
| E | .770 | .799 | 19.56 | 20.29 | |
| е | .150 BSC | | 3.81 BSC | | |
| L | .780 | .820 | 19.81 | 20.83 | |
| L1 | .080 | .102 | 2.03 | 2.59 | |
| Q | .210 | .235 | 5.33 | 5.97 | |
| Q1 | .490 | .513 | 12.45 | 13.03 | |
| R | .150 | .180 | 3.81 | 4.57 | |
| R1 | .100 | .130 | 2.54 | 3.30 | |
| S | .668 | .690 | 16.97 | 17.53 | |
| T | .801 | .821 | 20.34 | 20.85 | |
| U | .065 | .080 | 1.65 | 2.03 | |
| ٧ | .440 | .460 | 11.18 | 11.68 | |

Note 1: Pulse test, $t \le 300\mu s$; duty cycle, $d \le 2\%$.

ADVANCE TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.